

# **Excellent Integrated System Limited**

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Vishay/Siliconix SUD50N04-16P-E3

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>





### SUD50N04-16P

Vishay Siliconix

# N-Channel 40-V (D-S), 175 °C MOSFET

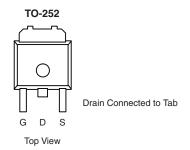
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A) <sup>a, c</sup>	Q <sub>g</sub> (Typ.)			
40	0.016 at V <sub>GS</sub> = 10 V	20	15.6 nC			
	0.018 at V <sub>GS</sub> = 4.5 V	20	15.0110			

#### **FEATURES**

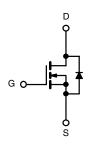
- TrenchFET<sup>®</sup> Power MOSFET
- 100  $\%~\text{R}_{\text{q}}$  and UIS Tested

#### **APPLICATIONS**

- LCD TV Inverter
- Secondary Synchronous Rectification



Ordering Information: SUD50N04-16P-E3 (Lead (Pb)-free)



N-Channel MOSFET

**ABSOLUTE MAXIMUM RATINGS**  $T_A = 25$  °C, unless otherwise noted Parameter Symbol Limit Unit V<sub>DS</sub> 40 Drain-Source Voltage ٧ Gate-Source Voltage V<sub>GS</sub> ± 16 20<sup>c</sup> T<sub>C</sub> = 25 °C T<sub>C</sub> = 100 °C 20<sup>c</sup> Continuous Drain Current (T<sub>J</sub> = 150 °C)  $I_D$ 9.8<sup>b</sup> T<sub>A</sub> = 25 °C 6.8<sup>b</sup> T<sub>A</sub> = 100 °C А Pulsed Drain Current 50  $I_{DM}$ T<sub>C</sub> = 25 °C 20<sup>c</sup> Continuous Source-Drain Diode Current  $I_S$ 2.5<sup>b</sup> T<sub>A</sub> = 25 °C Single Pulse Avalanche Current 20  $I_{AS}$ L = 0.1 mHAvalanche Energy E<sub>AS</sub> 20 m.J T<sub>C</sub> = 25 °C 35.7 T<sub>C</sub> = 100 °C 17.8 W Maximum Power Dissipation  $\mathsf{P}_\mathsf{D}$ T<sub>A</sub> = 25 °C 3.1<sup>b</sup> T<sub>A</sub> = 100 °C 1.5<sup>b</sup> T<sub>J</sub>, T<sub>stg</sub> °C Operating Junction and Storage Temperature Range - 55 to 175

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Typical Maximum		Unit			
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	40	50	°C/W			
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	3.4	5.3	0/11			

Notes:

a. Based on  $T_C = 25$  °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Package limited.

Document Number: 74477 S-81956-Rev. B, 25-Aug-08





# SUD50N04-16P

Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-					1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$			38		mV/°0	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5.4			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	0.8		2.2	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 16 V$			± 100	nA	
	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	иА	
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 ^{\circ}\text{C}$			20		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 V, V_{GS} = 10 V$	30			Α	
	_ ` `	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		0.0125	0.016	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.014	0.018		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{\rm DS} = 15 \text{ V}, I_{\rm D} = 15 \text{ A}$		58		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			1655		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		200			
Reverse Transfer Capacitance	C <sub>rss</sub>			152			
		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 30 \text{ A}$		39.2	60	nC	
Total Gate Charge	Qg			15.6	24		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		4.2			
Gate-Drain Charge	Q <sub>gd</sub>			5.5			
Gate Resistance	R <sub>q</sub>	f = 1 MHz		2.1	3.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 20 V, R <sub>L</sub> = 0.66 $\Omega$ I <sub>D</sub> $\cong$ 30 A, V <sub>GEN</sub> = 4.5 V, R <sub>q</sub> = 1 $\Omega$		19	30		
Rise Time	t <sub>r</sub>			120	180		
Turn-Off Delay Time	t <sub>d(off)</sub>			40	60		
Fall Time	t <sub>f</sub>			36	55		
Turn-On Delay Time	n-On Delay Time t <sub>d(on)</sub>			8	16	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 0.66 \Omega$		22	35	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 30$ Å, $V_{GEN} = 10$ V, $R_g = 1$ $\Omega$		24	36		
Fall Time	t <sub>f</sub>	Ŭ		8	16		
Drain-Source Body Diode Characteris	tics						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			20	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A		0.84	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-		25	38	ns	
Body Diode Reverse Recovery Charge Q <sub>rr</sub>				22	33	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_{F} = 20 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_{J} = 25 ^{\circ}\text{C}$		15		ns	
-	~ ~						

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





## SUD50N04-16P

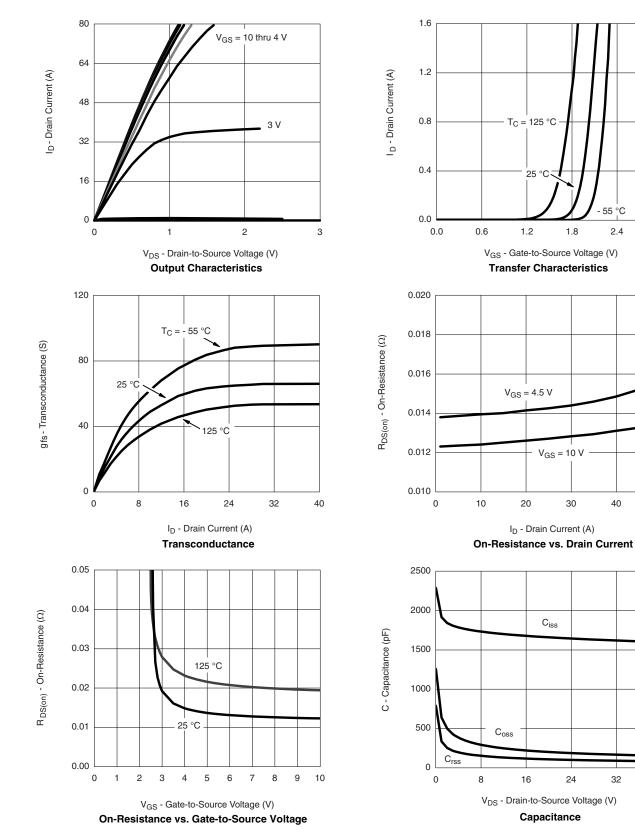
Vishay Siliconix

2.4

40

50

3.0



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

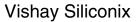
Document Number: 74477 S-81956-Rev. B, 25-Aug-08 40

32



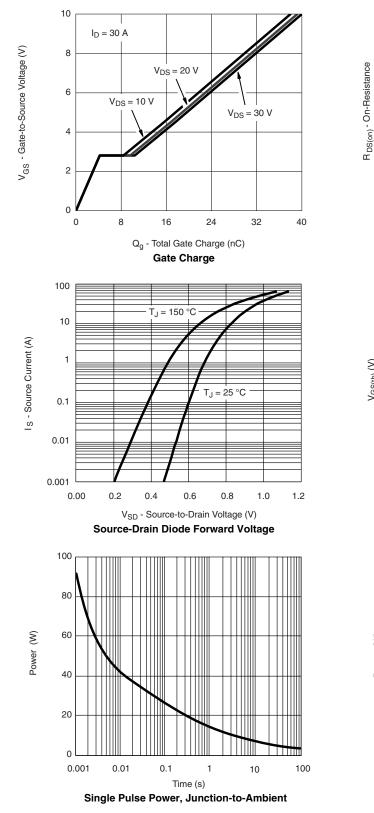
I<sub>D</sub> = 15 A

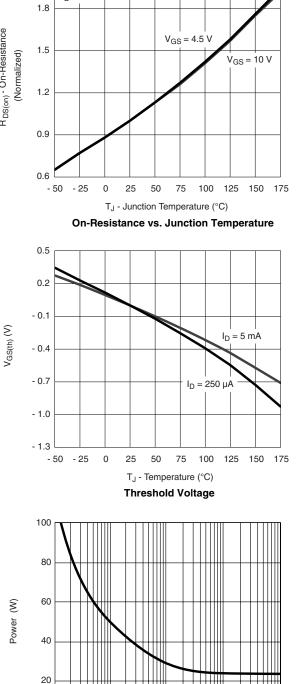
# SUD50N04-16P





### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



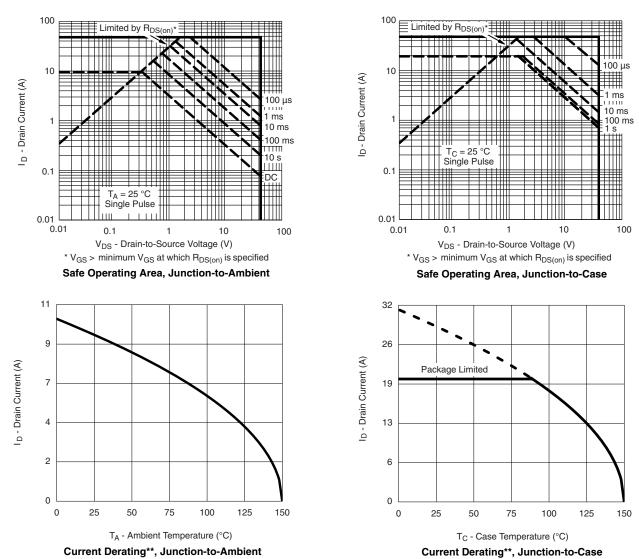






# SUD50N04-16P

Vishay Siliconix



**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

\*\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 175$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

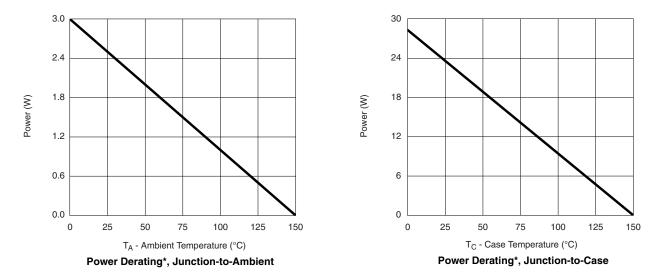


## SUD50N04-16P





#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 175$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

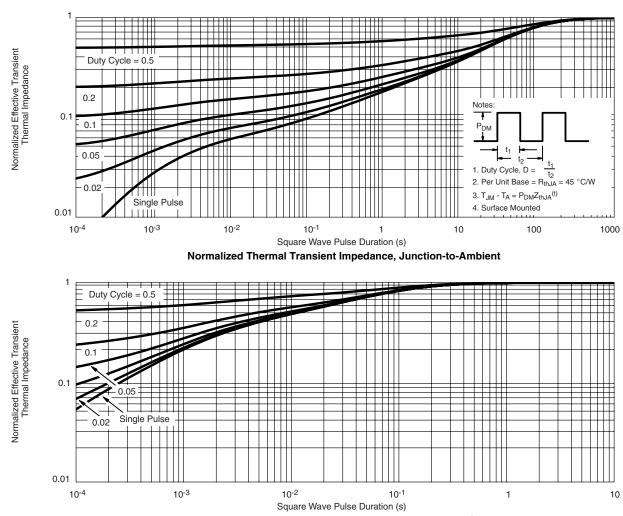




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

## SUD50N04-16P

**Vishay Siliconix** 



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?74477.





www.vishay.com

# Legal Disclaimer Notice

Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.